



Digital transition for satcom payloads

On Board Data Processing 2019 workshop – ESTEC – 02/25/2019

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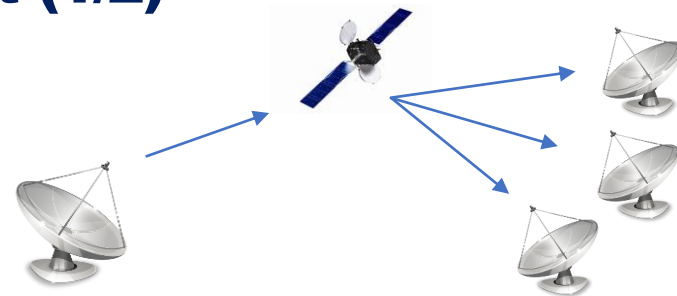
Agenda

- ❑ A growing and moving Telecom market
- ❑ From analog to digital satcom payload
- ❑ Past and current CNES activities
- ❑ Overview of future needs for satcom

A growing and moving Telecom market (1/2)

Broadcast (Linear TV)

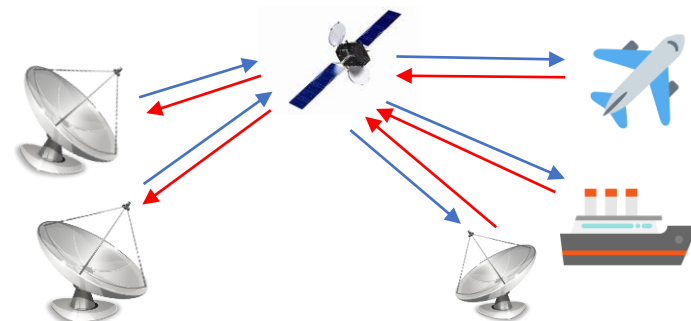
- Strong historical market (~ 300M subscribers worldwide in 2019)
- Stagnation or even decrease (in Europe & North America) of linear satellite TV market



- Unidirectional links
- Limited nb of TV channels but unlimited number of users

Broadband

- Historical : global telephony services, military connectivity
- Growing markets :
 - Fixed user (Residential & business) connectivity
 - Mobile user (Aero & maritime) connectivity
 - 3G/4G/5G cellular backhauling



- Bidirectional links
- Maximum number of users proportionnal to satellite capacity

A growing and moving Telecom market (2/2)

Broadcast (Linear TV)

- Progressive deployment of UHD TV channels, requiring more bandwidth for the same income
- Need for diversification of services : hybrid or generic satellite payload allowing to provide linear TV and broadband services

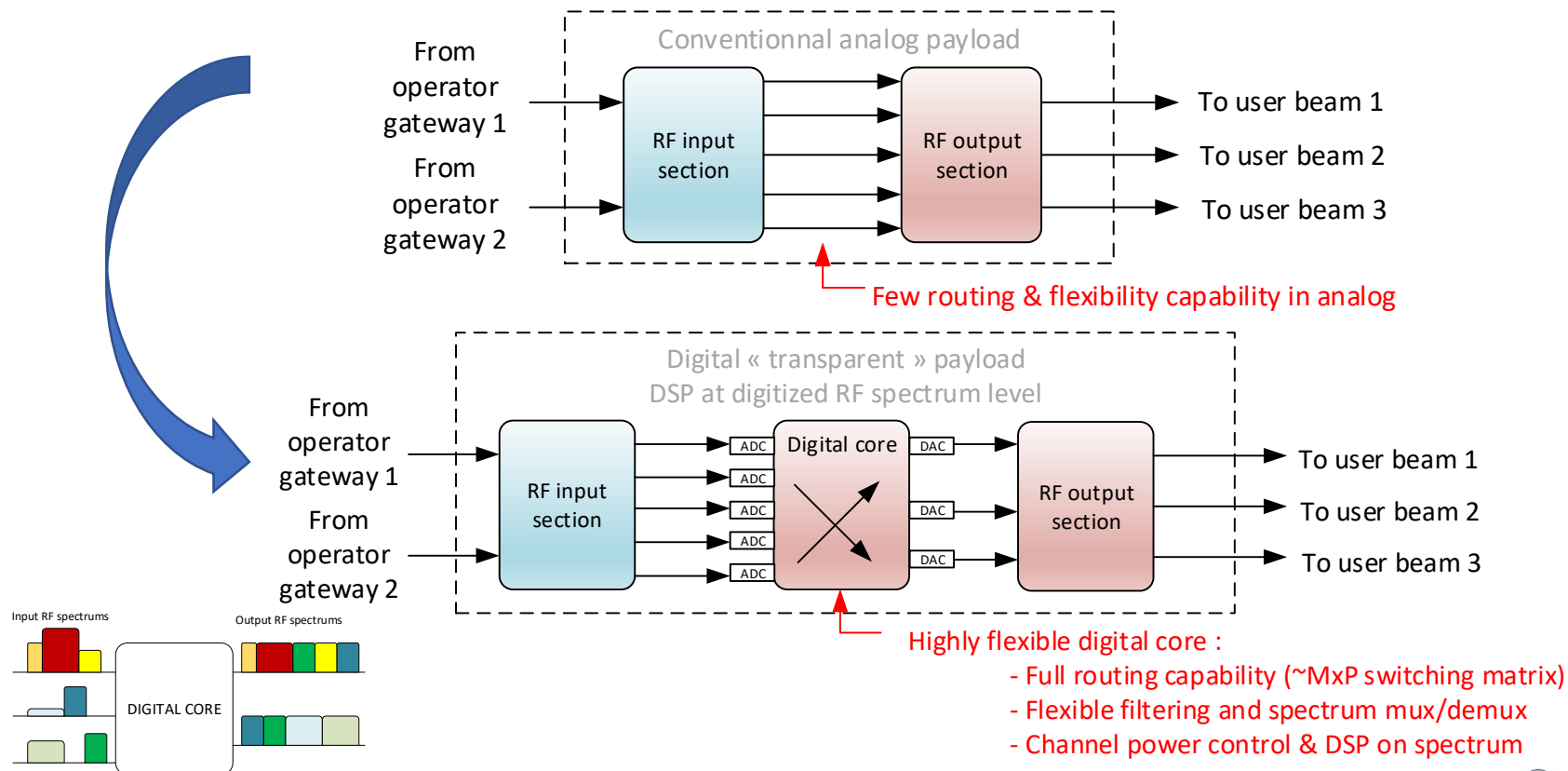
Broadband connectivity

- Increasing throughput per user at lower cost to meet needs and competition, requiring to increase offered satellite or system capacity
- Need for minimizing operator ground segment CAPEX & OPEX
- Need for optimizing capacity fill rate (objective : 1 Gbps offered = 1 Gbps used) in highly heterogeneous & variable bitrate demand in the service area

➤ **Need for highly efficient satellite system with large & flexible capacity**

From analog to digital payload (1/2)

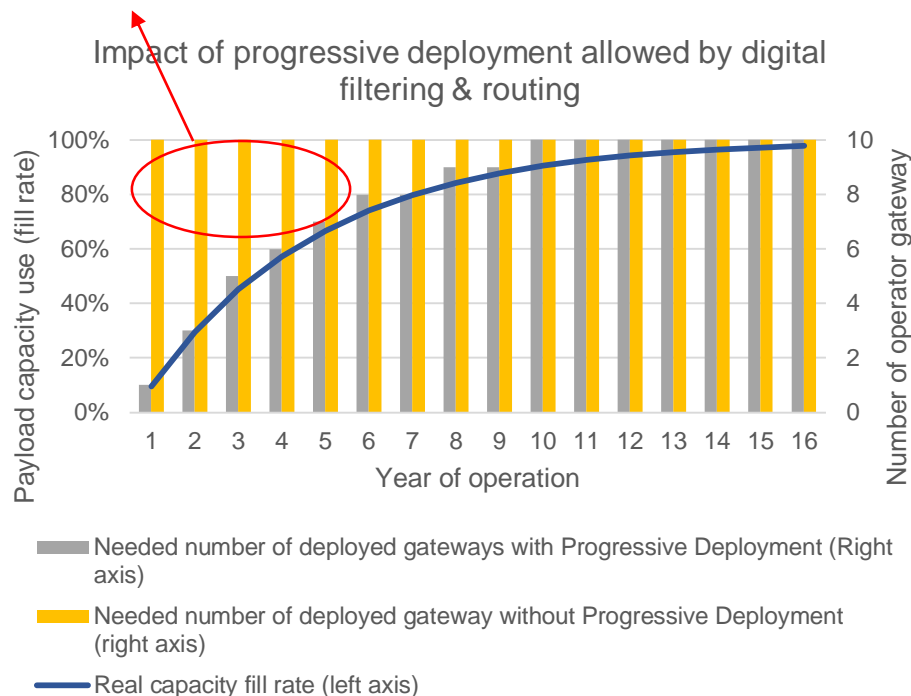
□ An example of digital transition at RF spectrum level



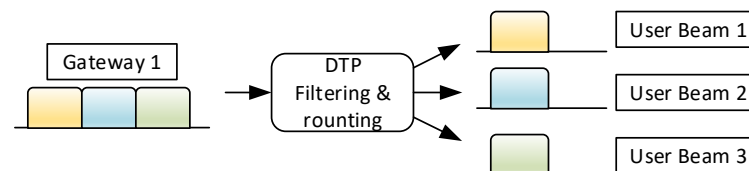
From analog to digital payload (2/2)

❑ Digital routing and filtering flexibility can be highly efficient in cost saving : example of Ground segment progressive deployment

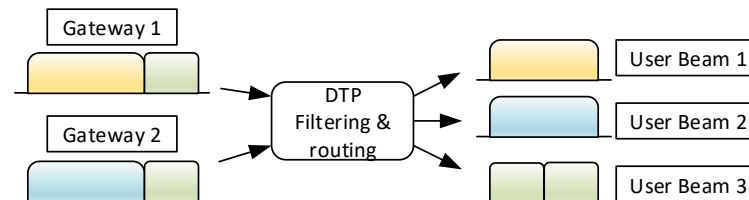
Delaying and adjusting ground segment CAPEX at real need
Reducing ground segment OPEX



At T0+N : 50% capacity required => only N/2 deployed gateways



At T0+P : 100% capacity required => N deployed gateways

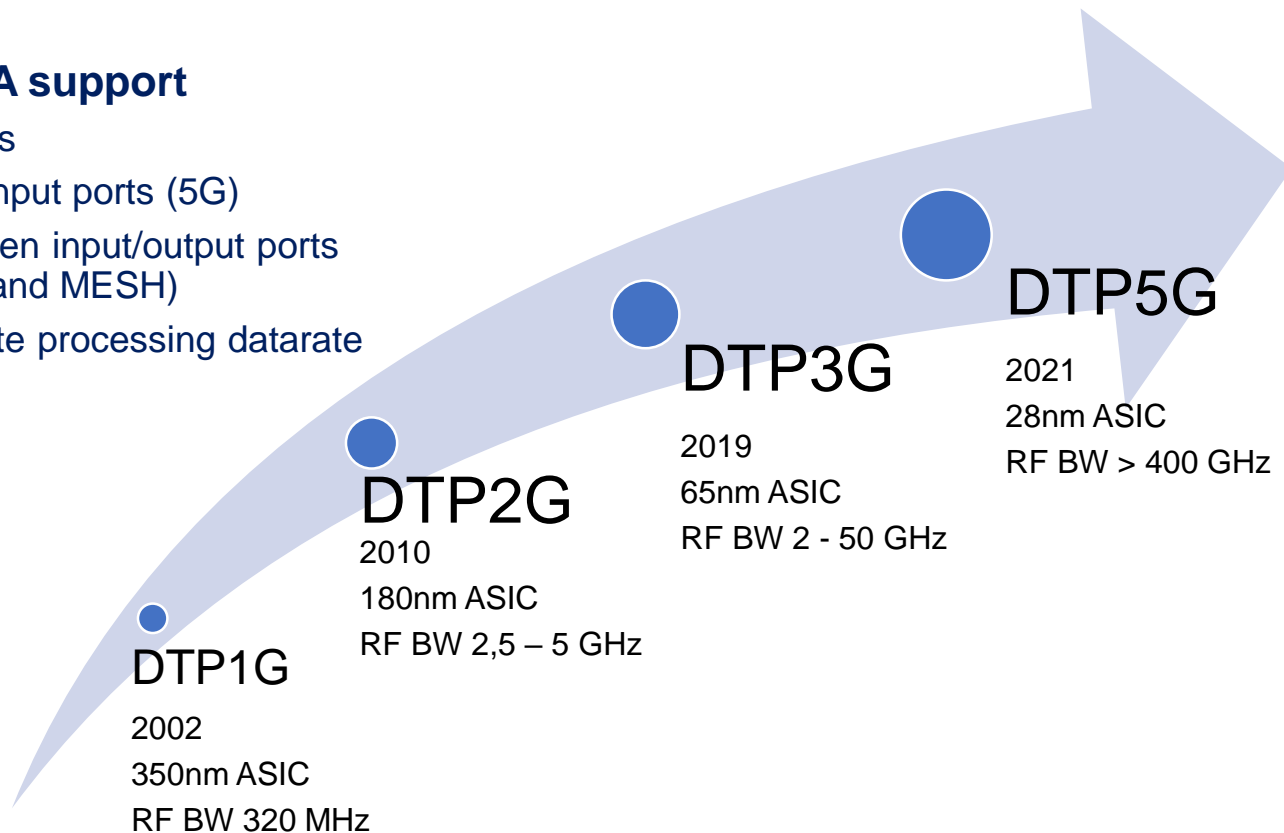


Past & current CNES activities for digital satcom (1/2)

❑ Product R&D example : Digital Transparent Processor family with Thales Alenia Space

➤ Historical CNES & ESA support

- IF ADC/DAC ~2x12 bits
- Up to 2,5 useful GHz input ports (5G)
- Full connectivity between input/output ports (including FWD, RTN and MESH)
- Up to 10Tbps aggregate processing data rate
- Generic product :
 - Broadband mission
 - Broadcast mission
 - Military mission



Past & current CNES activities for digital satcom (2/2)

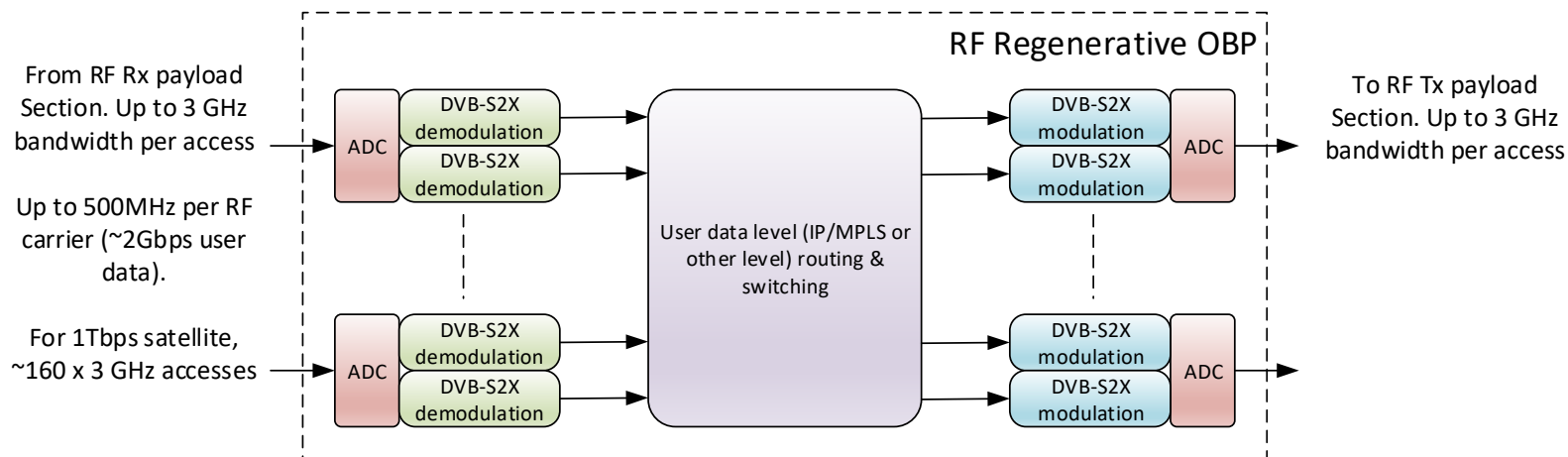
A wide range of topics internally studied and supported by CNES, including :

- ☐ **Avionics activities : Dahlia architecture & Hi-Rel NanoXplore FPGA**
- ☐ **Software Defined Radio**
- ☐ **Optical HSSL**
- ☐ **Thermal control**
- ☐ **Packaging**
- ☐ **DC/DC function**
- ☐ **COTS parts**

Overview of future needs for satcom (1/4)

❑ RF regenerative On Board Data Processors

- ❖ Unlike transparent configuration with RF spectrum processing, user data is demodulated, processed and re-modulated
- ❖ Pros
 - Highly efficient and flexible way to route user data
 - Reduction of needed gateway sites by using improved spectral efficiency on feeder link
 - Improved overall ground-to-ground efficiency by cutting uplink and downlink budget links (with dedicated uplink decoding)
- ❖ Cons
 - Increased payload digital complexity versus digital transparent configuration (need for on board high speed demodulation & decoding, modulation & coding via ASIC or FPGA technologies, need for strong software capability to manage user data routing schemes...)
 - If ASIC technology is used for demodulation & modulation, feeder and user RF waveforms cannot be changed. If FPGA technology is used, risk of excessive DC consumption.



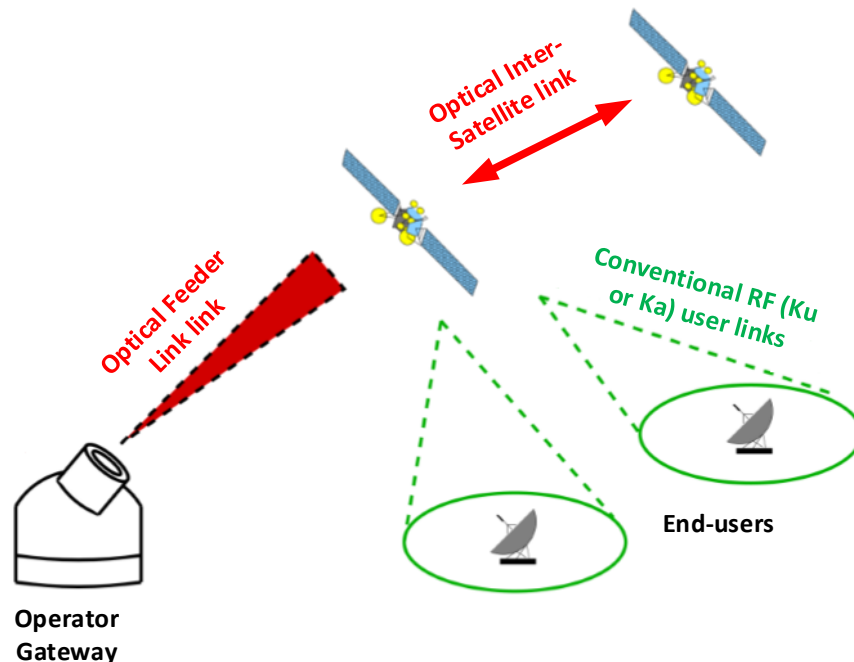
Overview of future needs for satcom (2/4)

□ Digital Processing Unit for Optical Link

- Optical feeder : partial ou full replacement of numerous RF feeder links (gateway/satellite) by fewer optical links
- Optical Inter-satellite : optical links between satellites to exchange data and create a space constellation-type network (LEO, MEO or GEO)

Main constraints for digital :

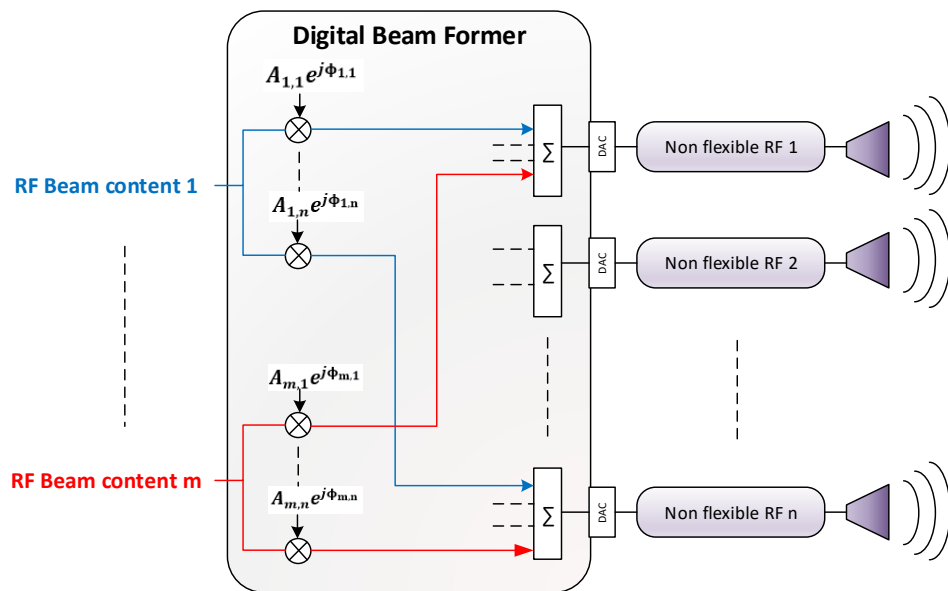
- Use of free-space optical transmission for feeder or inter-satellite links requires very high speed processing (incl. FEC), typ. up to 100Gbps per optical channel)
- In function of chosen optical transport, same cons as in RF regenerative OBP
- High speed memory for optical channel interleaving in FL application



Overview of future needs for satcom (3/4)

❑ Digital Beam Forming for Ka, Ku or Q/V Active antenna

- ❑ In HTS or VHTS multi-beam system, digital-based active antennas allow to change RF antenna pattern (in Rx or Tx) by only changing digital coefficients



A_{xx} & ϕ_{xx} coefficients can be updated via :

- TM/TC at slow rate
- Cyclic table (high speed ~1kHz) for Beam Hopping application



- Requires $m \times n$ complex multiplications at sampling rate (typ. 3GHz)
- Requires $m \times (n \text{ to } n)$ fixed routing (high speed interconnexion if DBFN if made of several chipset)
- Concurrent to analog BFN implementation
- Can offer full spatial & frequency flexibility if combined with DTP/OBP routing capability (requires more than $m \times n$ coefficients)
- Requires reliable digital & RF calibration : delays or phase offset between paths strongly degrades pattern

Overview of future needs for satcom (4/4)

❑ Main trade-offs for each digital equipment

- **FPGA/ASIC trade-off for wideband processing**
 - COTS or HiRel component trade-off in case of FPGA choice
 - ASIC technology node in case of ASIC choice
- **CPU trade-off for software processing**
- **High speed interconnexions and overall routing strategy**
- **TM/TC, reconfiguration and calibration strategies**
- **ENOB and digital processing impacts on the equivalent equipment noise figure**
- **High-speed ADC & DAC component trade-off and input frequency trade-off (IF or RF)**
- **Thermal dissipation management**
- **Redundancy schemes for digital cores & boards in function of expected reliability**

❑ Main metrics

- **S(ize) W(eight) and P(ower) of equipment**
- **Cost**
- **Mission performances (noise figure, reliability, scalability & flexibility...)**



Thank you for your attention